

PTC thermistors for overcurrent protection in telecom applications

Telecom Pair Protector (TPP) for GR-1089 Central Office, SMD

Series/Type: B59970T1100A*62

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Telecom pair protector (TPP) for GR-1089 Central Office

T1970

SMD

Applications

- Overcurrent protection for telecom applications
- Suitable for line card applications e.g. POTS, access networks, customer premises equipment (CPE) or integrated voice data (IVD)

Internal circuit



Features

- Two resistance-matched PTCs in a plastic housing
- Compliant with GR-1089, edition 5 Central Office requirements
- Compliant with GR-1089, edition 5 (telecommunication ports)
 - Lightning surge, level 1 and 2
 - Lightning surge intra building
 - AC power fault, level 1 and 2
 - AC power fault, customer premises and intra building
- Compliant with ITU-T standards
 - basic-level lightning surges (10/700 μs)
 - basic-level power induction (600 V, 1 A, 0.2 s)
 - power contact criteria A/B (230 V, 15 min.)
- Suitable for continuous connection to mains voltages of 110/230 V AC in tripped (high-ohmic) condition
- Housing material according to UL94-V0
- UL approval to UL 1434 (file number E69802)
- Tight resistance matching maintained after switching
- Negligible resistance drift after reflow soldering or switching
- Marked with manufacturer's logo, type designation and date code
- RoHS-compatible

Options

Alternative tolerances and resistances on request

Delivery mode

■ Blister tape, 380-mm reel with 24-mm tape, taping to IEC 60286-3

General technical data

Maximum fault voltage ¹⁾		$V_{F,max}$	600	V AC
Max. operating voltage		V_{max}	135	V AC
Operating temperature range	(V = 0)	T _{op}	-40/+125	°C
Operating temperature range	$(V = V_{max})$	T _{op}	0/+60	°C

¹⁾ The maximum fault voltage V_{F,max} is the highest voltage that is permitted to be applied across the PTC thermistor in protection mode.



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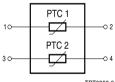
Electrical specifications and ordering code

Туре	R _R	ΔR_R	I _R @ 25 °C	I _R @ 70 °C	I _s @ 25 °C	I _s @ 70 °C	Approvals	Ordering code
	Ω	%	mA	mA	mA	mA	<i>9</i> 77	
T1970	70	±15	70	40	150	85	Χ	B59970T1100A062
T1970	70	±15	70	40	150	85	Χ	B59970T1100A162

Switching times, resistance matching and ordering code

Type	Resistance matching in one housing $ R_2 - R_1 $	t _s @ 0.15 A	t _s @ 1 A	t _s @ 2.5 A	Ordering code
	Ω	s	s	s	
T1970	< 1.0	< 100	< 1	< 0.15	B59970T1100A162
T1970	< 2.0	< 100	< 1	< 0.15	B59970T1100A062

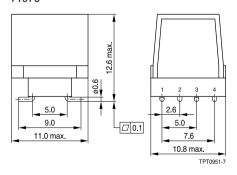
Internal circuit



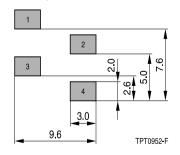
TPT0982-2

Dimensional drawings

T1970



Solder pad



Dimensions in mm



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Reliability data

Test	Standard	Test conditions	$ \Delta R_{25}/R_{25} $
Electrical endurance,	IEC 60738-1	Room temperature, I _{Smax} ; V _{max}	< 20%
cycling		Number of cycles: 10	
Electrical endurance,	IEC 60738-1	Storage at V_{max} and $T_{op,max}$ (@ V_{max})	< 25%
constant		Test duration: 1000 h	
Damp heat	IEC 60738-1	Temperature of air: 40 °C	< 10%
		Relative humidity of air: 93%	
		Duration: 56 days	
		Test according to IEC 60068-2-78	
Rapid change	IEC 60738-1	$T_1 = T_{op,min} (0 \text{ V}), T_2 = T_{op,max} (0 \text{ V})$	< 10%
of temperature		Number of cycles: 5	
		Test duration: 30 min	
		Test according to IEC 60068-2-14, test Na	
Vibration	IEC 60738-1	Frequency range: 10 to 55 Hz	< 5%
		Displacement amplitude: 0.75 mm	
		Test duration: $3 \times 2 \text{ h}$	
		Test according to IEC 60068-2-6, test Fc	
Shock	IEC 60738-1	Acceleration: 400 m/s ²	< 5%
		Pulse duration: 6 ms; 6 × 5000 pulses	
Climatic sequence	IEC 60738-1	Dry heat: $T = T_{op,max}(0 \text{ V})$	< 10%
		Test duration: 16 h	
		Damp heat first cycle	
		Cold: $T = T_{op,min} (0 \text{ V})$	
		Test duration: 2 h	
		Damp heat 5 cycles	
		Tests performed according to	
		IEC 60068-2-30	



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Cautions and warnings

General

- EPCOS thermistors are designed for specific applications and should not be used for purposes not identified in our specifications, application notes and data books unless otherwise agreed with EPCOS during the design-in-phase.
- Ensure suitability of thermistor through reliability testing during the design-in phase. The thermistors should be evaluated taking into consideration worst-case conditions.

Storage

- Store thermistors only in original packaging. Do not open the package prior to processing.
- Storage conditions in original packaging: storage temperature −25 °C ... +45 °C, relative humidity ≤75% annual mean, maximum 95%, dew precipitation is inadmissible.
- Avoid contamination of thermistors surface during storage, handling and processing.
- Avoid storage of thermistor in harmful environment with effect on function on long-term operation (examples given under operation precautions).
- Use thermistor within the following period after delivery:
 - Through-hole devices (housed and leaded PTCs): 24 months
 - Motor protection sensors, glass-encapsulated sensors and probe assemblies: 24 months
 - Telecom pair and quattro protectors (TPP, TQP): 24 months
 - Leadless PTC thermistors for pressure contacting: 12 months
 - Leadless PTC thermistors for soldering: 6 months
 - SMDs in EIA sizes 3225 and 4032, and for PTCs with metal tags: 24 months
 - SMDs in EIA sizes 1210 and smaller: 12 months

Handling

- PTCs must not be dropped. Chip-offs must not be caused during handling of PTCs.
- The ceramic and metallization of the components must not be touched with bare hands. Gloves are recommended
- Avoid contamination of thermistor surface during handling.

Soldering (where applicable)

- Use rosin-type flux or non-activated flux.
- Insufficient preheating may cause ceramic cracks.
- Rapid cooling by dipping in solvent is not recommended.
- Complete removal of flux is recommended.
- Standard PTC heaters are not suitable for soldering.



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Mounting

- Electrode must not be scratched before/during/after the mounting process.
- Contacts and housing used for assembly with thermistor have to be clean before mounting. Especially grease or oil must be removed.
- When PTC thermistors are encapsulated with sealing material, the precautions given in chapter "Mounting instructions", "Sealing and potting" must be observed.
- When the thermistor is mounted, there must not be any foreign body between the electrode of the thermistor and the clamping contact.
- The minimum force and pressure of the clamping contacts pressing against the PTC must be 10 N and 50 kPa, respectively. In case the assembly is exposed to mechanical shock and/ or vibration this force should be higher in order to avoid movement of the PTC during operation.
- During operation, the thermistor's surface temperature can be very high. Ensure that adjacent components are placed at a sufficient distance from the thermistor to allow for proper cooling at the thermistors.
- Ensure that adjacent materials are designed for operation at temperatures comparable to the surface temperature of thermistor. Be sure that surrounding parts and materials can withstand this temperature.
- Avoid contamination of thermistor surface during processing.

Operation

- Use thermistors only within the specified temperature operating range.
- Use thermistors only within the specified voltage and current ranges.
- Environmental conditions must not harm the thermistors. Use thermistors only in normal atmospheric conditions. Avoid use in deoxidizing gases (chlorine gas, hydrogen sulfide gas, ammonia gas, sulfuric acid gas etc), corrosive agents, humid or salty conditions. Contact with any liquids and solvents should be prevented.
- Be sure to provide an appropriate fail-safe function to prevent secondary product damage caused by abnormal function (e.g. use VDR for limitation of overvoltage condition).

This listing does not claim to be complete, but merely reflects the experience of EPCOS AG.

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Symbols and terms

Symbol	Term
A	Area
С	Capacitance
C_{th}	Heat capacity
f	Frequency
1	Current
I _{max}	Maximum current
I_R	Rated current
I _{res}	Residual current
I _{PTC}	PTC current
I_r	Residual currrent
$I_{r,oil}$	Residual currrent in oil (for level sensors)
$I_{r,air}$	Residual currrent in air (for level sensors)
I _{RMS}	Root-mean-square value of current
Is	Switching current
I _{Smax}	Maximum switching current
LCT	Lower category temperature
N	Number (integer)
N_c	Operating cycles at V _{max} , charging of capacitor
N_{f}	Switching cycles at V _{max} , failure mode
Р	Power
P ₂₅	Maximum power at 25 °C
P_{el}	Electrical power
P_{diss}	Dissipation power
R_G	Generator internal resistance
R_{min}	Minimum resistance
R_R	Rated resistance @ rated temperature T _R
ΔR_R	Tolerance of R _R
R_P	Parallel resistance
R_{PTC}	PTC resistance
R_{ref}	Reference resistance
R_s	Series resistance
R ₂₅	Resistance at 25 °C
R _{25,match}	Resistance matching per reel/ packing unit at 25 °C
ΔR_{25}	Tolerance of R ₂₅



Overcurrent protection for telecom Telecom pair protector (TPP) for GR-1089 Central Office T1970 **SMD** Т Temperature t Time TΔ Ambient temperature Thermal threshold time $T_{\rm C}$ Ferroelectric Curie temperature Settling time (for level sensors) t⊨ Ть Rated temperature @ 25 °C or otherwise specified in the data sheet Sensing temperature Tsense Operating temperature Ton T_{PTC} PTC temperature Response time t₽ T_{ref} Reference temperature Temperature at minimum resistance T_{Bmin} Switching time t۹ Teurf Surface temperature UCT Upper category temperature V or Val Voltage (with subscript only for distinction from volume) $V_{c(max)}$ Maximum DC charge voltage of the surge generator Maximum voltage applied at fault conditions in protection mode V_{F max} V_{RMS} Root-mean-square value of voltage Breakdown voltage V_{RD} V_{ins} Insulation test voltage $V_{link.max}$ Maximum link voltage V_{max} Maximum operating voltage $V_{\text{max,dyn}}$ Maximum dynamic (short-time) operating voltage V_{meas} Measuring voltage $V_{\text{meas,max}}$ Maximum measuring voltage V۵ Rated voltage Voltage drop across a PTC thermistor V_{PTC} Temperature coefficient α Tolerance, change Δ

 δ_{th}

λ

e

Dissipation factor

Lead spacing (in mm)

Failure rate

Thermal cooling time constant



Important notes

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